

گروه فنی مهندسی جوش و برش مقدم

اعتماد از شما کیفیت و تخصص از ما



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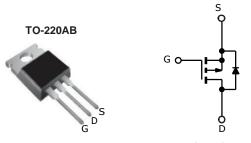


- 7 سال سابقه آموزش تعمیرات تخصصی دستگاه های جوش اینورتری تک فاز و 3 فاز
- 7 سال سابقه فروش قطعات الکترونیکی دستگاه جوش
 تک فاز و 3 فاز
- آموزش تخصصی تحلیل دستگاه های جوش اینورتری مختص ابراز فروشان
 - آموزش تخصصی ابراز آلات شارژی





Power MOSFET



P-Channel MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	-100			
$R_{DS(on)}(\Lambda)$	$V_{GS} = -10 \text{ V}$	0.20		
Q _g max. (nC)	61			
Q _{gs} (nC)	14			
Q _{gd} (nC)	29			
Configuration	Single			

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- P-channel
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF9540PbF		
Lead (Pb)-free and halogen-free	IRF9540PbF-BE3		

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	-100	V	
Gate-source voltage			V_{GS}	± 20		
Continuous drain current	V _{GS} at 10 V	T _C = 25 °C	ID	-19	A	
		T _C = 100 °C	1D	-13		
Pulsed drain current ^a			I _{DM}	-72	1	
Linear derating factor				1.0	W/°C	
Single pulse avalanche energy ^b			E _{AS}	640	mJ	
Repetitive avalanche current ^a			I _{AR}	-19	Α	
Repetitive avalanche energy ^a			E _{AR}	15	mJ	
Maximum power dissipation	T _C = 25 °C		P _D	150	W	
Peak diode recovery dV/dt ^c			dV/dt	-5.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^d	For 10 s			300	7	
Mounting torque	6-32 or M3 screw			10	lbf · in	
Mounting torque				1.1	N·m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. $V_{DD} = -25 \text{ V}$, starting $T_{J} = 25 \text{ °C}$, L = 2.7 mH, $R_{g} = 25 \text{ }\Lambda$, $I_{AS} = -19 \text{ A}$ (see fig. 12)
- c. $I_{SD} \le$ -19 A, $dI/dt \le$ 200 A/ μ s, $V_{DD} \le V_{DS}$, $T_{J} \le$ 175 °C
- d. 1.6 mm from case



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62		
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	1.0		

PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V, } I_{D} = -250 \mu\text{A}$		-100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = -1 mA		-0.087	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V$	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-	-4.0	٧
Gate-source leakage	I_{GSS}	Vo	$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
Zoro gato voltago drain guerrant	т	$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	-100	μΑ
Zero gate voltage drain current	I_{DSS}	$V_{DS} = -80 \text{ V, }^{1}$	$V_{DS} = -80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 \text{ °C}$		-	-500	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = -10 V	I _D = -11 A ^b	-	-	0.20	Λ
Forward transconductance	9 _{fs}	$V_{DS} = -5$	50 V, I _D = -11 A ^b	6.2	-	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V,}$ $V_{DS} = -25 \text{ V,}$ f = 1.0 MHz, see fig. 5		-	1400	-	
Output capacitance	C _{oss}			-	590	-	pF
Reverse transfer capacitance	C_{rss}			-	140	-	
Total gate charge	Q_g			-	-	61	
Gate-source charge	Q_{gs}	$V_{GS} = -10 \text{ V}$ $I_{D} = -19 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13 b		-	-	14	nC
Gate-drain charge	Q_{gd}	30	see rig. 0 and 15	-	-	29	1
Turn-on delay time	t _{d(on)}			-	16	-	
Rise time	t _r	$V_{DD} = -50 \text{ V, } I_D = -19 \text{ A,}$ $R_g = 9.1 \Lambda, R_D = 2.4 \Lambda, \text{ see fig. } 10^{\text{ b}}$		-	73	-	ns
Turn-off delay time	t _{d(off)}			-	34	-	
Fall time	t _f			-	57	-	
Gate input resistance	R_g	f = 1 MHz, open drain		0.3	-	1.6	Λ
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal source inductance	Ls			-	7.5	-	'"'
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	-19	А
Pulsed diode forward current ^a	I_{SM}			-	-	-72	, A
Body diode voltage	V_{SD}	T _J = 25 °C, I _S = -19 A, V _{GS} = 0 V b		-	-	-5.0	V
Body diode reverse recovery time	t _{rr}	$T_{\rm J} = 25$ °C, $I_{\rm F} = -19$ A, $dI/dt = 100$ A/ μ s b		-	130	260	ns
Body diode reverse recovery charge	Q _{rr}			-	0.35	0.70	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_S			L _D)		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

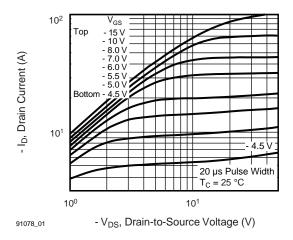


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

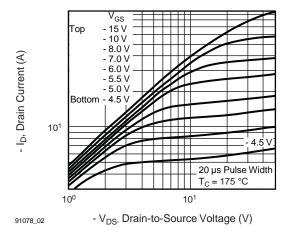


Fig. 2 - Typical Output Characteristics, T_C = 175 ° C

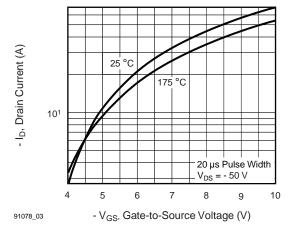


Fig. 3 - Typical Transfer Characteristics

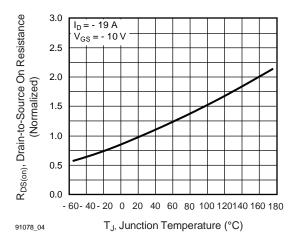


Fig. 4 - Normalized On-Resistance vs. Temperature

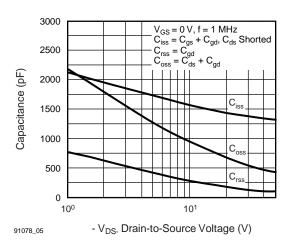


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

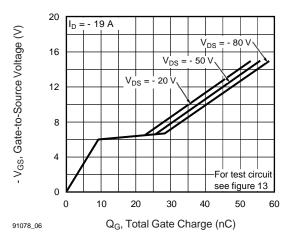


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



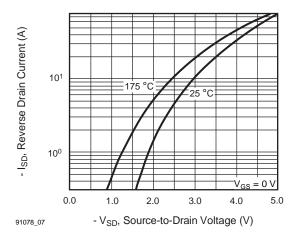


Fig. 4 - Typical Source-Drain Diode Forward Voltage

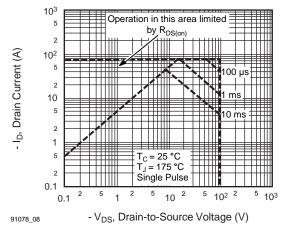


Fig. 5 - Maximum Safe Operating Area

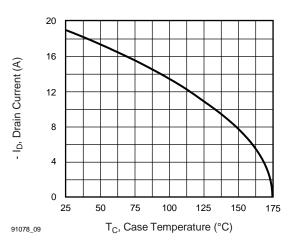


Fig. 6 - Maximum Drain Current vs. Case Temperature

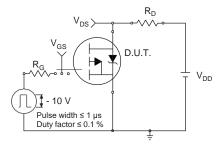


Fig. 10a - Switching Time Test Circuit

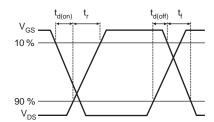


Fig. 10b - Switching Time Waveforms

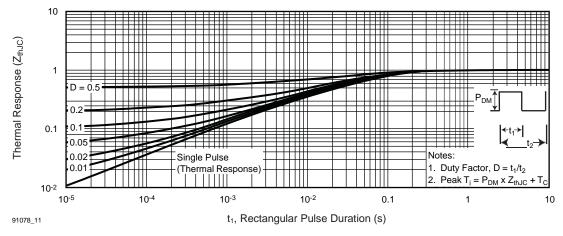


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



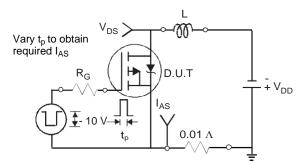


Fig. 12a - Unclamped Inductive Test Circuit

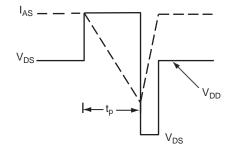


Fig. 12b - Unclamped Inductive Waveforms

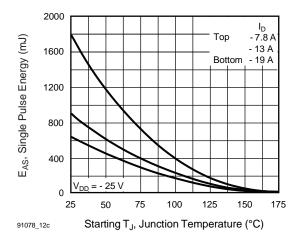


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

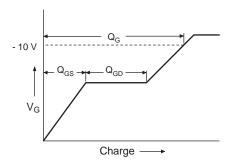


Fig. 13a - Basic Gate Charge Waveform

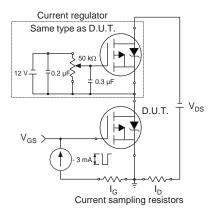
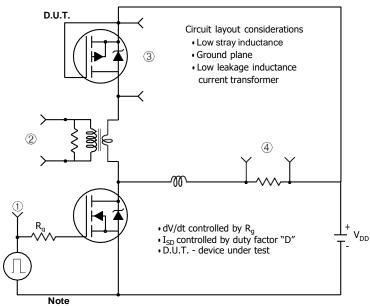


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

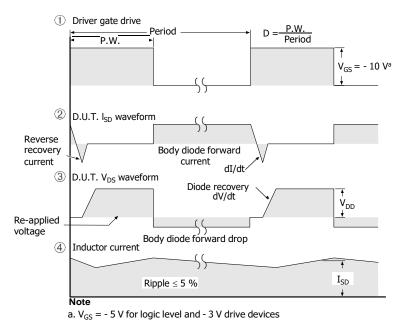


Fig. 14 - For P-Channel

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